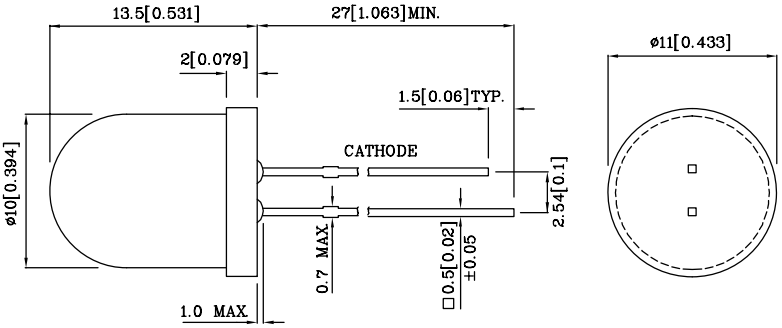
SunLED
www.SunLED.com

Part Number: **LBG01WE**

10mm SOLID STATE LAMP

Features

- ●10mm DIAMETER BIG LAMP.
- ●I.C. COMPATIBLE.
- ●RELIABLE AND RUGGED.
- ●LONG LIFE - SOLID STATE RELIABILITY.
- ●RoHS COMPLIANT.



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

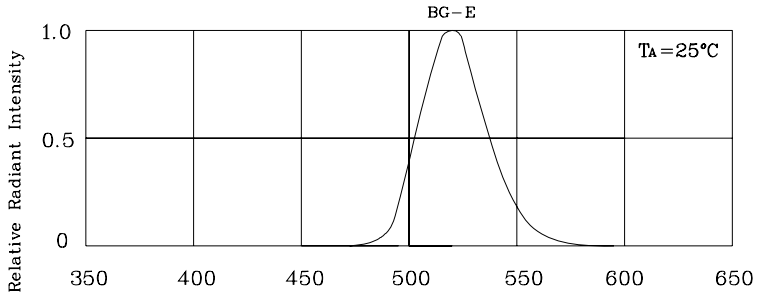
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25(0.01") unless otherwise noted.

Absolute Maximum Ratings (T_A=25°C)		**BG-E (InGaN)**	**Unit**
Reverse Voltage	V_R	5	V
Forward Current	I_F	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	iFS	100	mA
Power Dissipation	P_T	120	mW
Operating Temperature	T_A	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	
Electrostatic Discharge Threshold (HBM)		1000	V
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds		
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds		

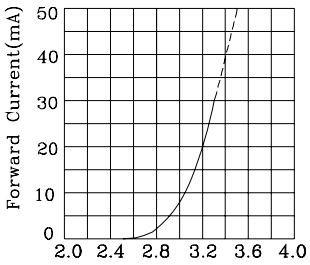
Operating Characteristics (T_A=25°C)		**BG-E (InGaN)**	**Unit**
Forward Voltage (Typ.) (I_F=20mA)	V_F	3.2	V
Forward Voltage (Max.) (I_F=20mA)	V_F	4.0	V
Reverse Current (Max.) (V_R=5V)	I_R	10	uA
Wavelength of Peak Emission (Typ.) (I_F=20mA)	λ P	520	nm
Wavelength of Dominant Emission (Typ.) (I_F=20mA)	λ D	525	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I_F=20mA)	Δλ	35	nm
Capacitance (Typ.) (V_F=0V, f=1MHz)	C	100	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
LBG01WE	Green	InGaN	Water Clear	2800	4090	520	15°

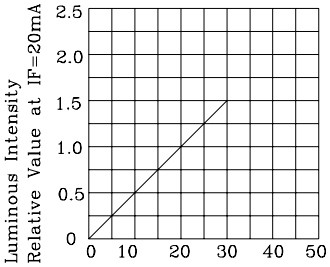


RELATIVE INTENSITY Vs. WAVELENGTH

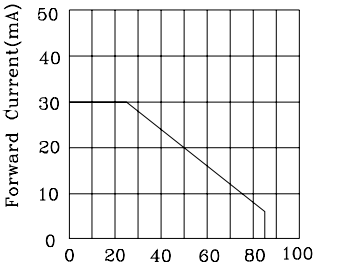
❖ BG-E



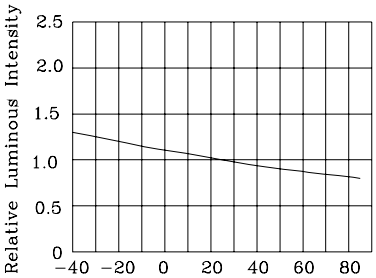
FORWARD CURRENT Vs.
FORWARD VOLTAGE



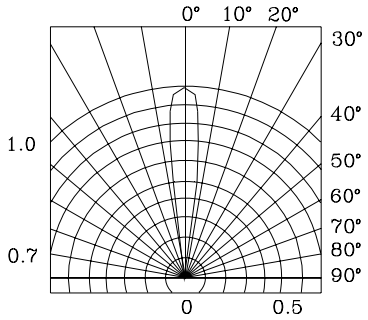
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

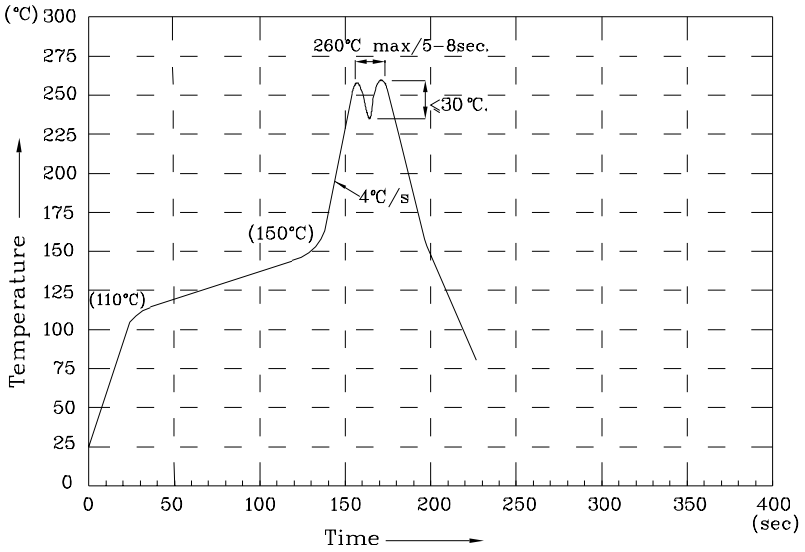


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1. Recommend the wave temperature 245℃~260℃. The maximum soldering temperature should be less than 260℃.
2. Do not apply stress on epoxy resins when temperature is over 85 degree℃.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. No more than once.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity/ luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous intensity/ luminous flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.